

U.S. DEPARTMENT OF COMP

FORM PTO-1596 1-31-92

**DOCKET NO. 2336-154** 

1,02340846

To the Honorable Commissioner of Patents and Trademarks: Please record the attached original documents or copy thereto:		
Name of conveying party(ies):	2. Name and address of receiving party(ies):	
1. Seok Taek JUN	Name: Samsung Electro-Mechanics Co., Ltd.	
2. Myoung Lib MOON 3. Duk Woo LEE	Internal Address:	
J. J. 100 LEE 0///3/23		
Additional name(s) of conveying part (ies) attached \( \square\) Yes \( \square\) No	Street Address: 314 Maetan-3-dong, Paldal-ku, Suwon,	
3. Nature of conveyance:		
☑ Assignment ☐ Merger	City: Kyungki-do State:	
☐ Security Agreement ☐ Change of Name	7' Country Daniell's of Warra	
☐ Other	Zip: Country: Republic of Korea	
Execution Date December 30, 2002	Additional name(s) & address(es) attached? ☐ Yes ☐ No	
4. Application number(s) or patent number(s):		
If the document is being filed together with a new application, the execution date of the application is: December 30, 2002		
A. Patent Application No(s).	B. Patent No(s).	
filed	issued	
l		
Additional numbers attached?		
5. Name and address of party to whom correspondence	6. Total number of applications and patents involved: one	
concerning document should be mailed:	7. Total fee (37 CFR 3.41).\$40.00	
Name:	□ Enclosed	
LOWE HAUPTMAN GILMAN & BERNER	☐ Authorized to be charged to deposit account	
Internal Address:	☐ Credit Card payment form enclosed	
Street Address: 1700 Diagonal Road, Suite 310	8. Deposit account number: 07-1337	
Sircei Address. I Add Diagonal Road, Suite 510	7	
City: Alexandria State: VA Zip: 22314		
DO NOT USE THIS SPACE		
9. Signature.	<b>/</b>	
///		
Designation I Humptone 20 210	January 13, 2003	
Benjamin J. Hauptman, 29,310  Name of Person, Registration No.	Signature Date	
Name of Ferson, Registration (vo.		
Total number of pages including cover sheet, attachment, and document: 3		
CMB No. 0851-0011 (exp. 4/94)		

01/15/2003 MAHMED1 00000001 10340680 03 FC:8021 40.00 DP

## **ASSIGNMENT**

In consideration of the premises and other good and valuable consideration in hand paid, the receipt and sufficiency of which is hereby acknowledged, the undersigned, (1) JUN, Seok Taek (4) \_\_\_\_\_ (2) MOON, Myoung Lib (5) \_\_\_\_\_ (3) LEE, Duk Woo (6) \_\_\_\_\_ who have made a certain new and useful invention, hereby sell, assign and transfer unto SAMSUNG ELECTRO-MECHANICS CO., LTD. 314 Maetan-3-dong, Paldal-ku, Suwon, Kyungki-do, Republic of Korea its successors and assigns (hereinafter designated "ASSIGNEE") the entire right, title and interest for the United States of America as defined in 35 U.S.C. 100 in the invention entitled <u>CERAMIC MULTILAYER SUBSTRATE AND</u> METHOD FOR MANUFACTURING THE SAME (a) for which an application for United States Letters Patent was filed on and identified by United States Serial No. \_\_\_\_\_; or (b) for which an application for United States Letters Patent was executed on and the undersigned hereby authorize and request the United States Commissioner of Patents and Trademarks to issue any and all United States Letters Patent which may be granted therefor and any and all extensions. divisions, reissues, substitutes, renewals, continuations, or continuations-inpart thereof, and the right to all benefits under the International Convention for the Protection of Industrial Property to the said ASSIGNEE, for its interest as ASSIGNEE, its successors, assigns and legal representatives; the undersigned agree that the attorneys of record in said application shall

hereafter act on behalf of said ASSIGNEE:

PATENT REEL: 013657 FRAME: 0378 AND the undersigned hereby agree to transfer a like interest, and to render all necessary assistance in making application for and obtaining original, divisional, reissued or extended Letters Patent of the United States, upon request of the said ASSIGNEE, its successors, assigns and legal representatives, and without further remuneration, in and to any improvements, and applications for patent based thereon, growing out of or related to the said invention; and to execute any papers by the said ASSIGNEE, its successors, assigns and legal representatives, deemed essential to ASSIGNEE's full protection and title in and to the invention hereby transferred.

SIGNED on the dates indicated aside our signatures:

**RECORDED: 01/13/2003** 

	INVENTOR(S)	DATE SIGNED
1)	.5000	December 30, 2002
	Name: JUN, Seok Taek	
2)	H. Hyoung Lib	December 30, 2002
	Name: MOON, Myoung Lib	
3)	Lee duk wo	December 30, 2002
•	Name: LEE, Duk Woo	

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